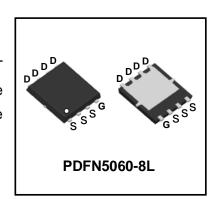


## 100V N-Channel Enhancement Mode Power MOSFET

## **Description**

WMB080N10HG2 uses Wayon's 2nd generation power trench MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.



#### **Features**

- $V_{DS} = 100V$ ,  $I_D = 74A$ (Silicon Limited)  $R_{DS(on)}$  <  $8m\Omega$  @  $V_{GS}$  = 10V
- Green Device Available
- 100% EAS Guaranteed
- Optimized for High Speed Smooth Switching

# **Applications**

- Hard Switching and High Speed Circuit
- DC/DC Conversion
- Synchronous Rectification in SMPS

# **Absolute Maximum Ratings**

| Parameter   |                       | Symbol          | Value      | Unit |  |
|---|-----------------------|-----------------|------------|------|--|
| Drain-Source Voltage                                    |                       | V <sub>DS</sub> | 100        | V    |  |
| Gate-Source Voltage                                     |                       | V <sub>GS</sub> | ±20        | V    |  |
| Continuous Drain Current <sup>1</sup> (Silicon Limited) | T <sub>C</sub> =25°C  | lь              | 74         | ^    |  |
|   | T <sub>C</sub> =100°C |                 | 47         | А    |  |
| Pulsed Drain Current <sup>2</sup>                       |                       | I <sub>DM</sub> | 260        | Α    |  |
| Single Pulse Avalanche Energy³                          |                       | EAS             | 204.8      | mJ   |  |
| Avalanche Current                                       |                       | I <sub>AS</sub> | 32         | А    |  |
| Total Power Dissipation <sup>4</sup>                    | T <sub>C</sub> =25°C  | P <sub>D</sub>  | 80.6       | W    |  |
| Operating Junction and Storage Temperature Range        |                       | ТЈ, Тѕтс        | -55 to 150 | °C   |  |

#### **Thermal Characteristics**

| Parameter  | Symbol | Value | Unit |
|--|--------|-------|------|
| Thermal Resistance from Junction-to-Ambient <sup>1</sup> | Reja   | 51    | °C/W |
| Thermal Resistance from Junction-to-Case <sup>1</sup>    | Rejc   | 1.55  | °C/W |



## Electrical Characteristics T<sub>c</sub> = 25°C, unless otherwise noted

| Parameter  |            | Symbol               | Test Conditions  | Min. | Тур. | Max. | Unit |  |
|--|------------|----------------------|--|------|------|------|------|--|
| Static Characteristics                           |            | •                    |  | •    |      |      |      |  |
| Drain-Source Breakdown Voltage                   |            | V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA                   | 100  | -    | -    | V    |  |
| Gate-Body Leakage Current                        |            | I <sub>GSS</sub>     | $V_{DS} = 0V, V_{GS} = \pm 20V$                                | -    | -    | ±100 | nA   |  |
| Zero Gate Voltage Drain<br>Current               | TJ=25°C    | IDSS                 | V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V                   | -    | -    | 1    | μA   |  |
| Gate-Threshold Voltage                           | TJ=100°C   | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA     | 2    | 3    | 100  | V    |  |
|  | .2         |                      |  |      |      |      |      |  |
| Drain-Source on-Resistance                       |            | R <sub>DS(on)</sub>  | V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A                    | -    | 7    | 8    | mΩ   |  |
| Forward Transconductance                         |            | <b>G</b> fs          | V <sub>DS</sub> = 5V, I <sub>D</sub> = 20A                     | -    | 40   | -    | S    |  |
| Dynamic Characteristic                           | S          | <u> </u>             | I  |      |      |      |      |  |
| Input Capacitance                                |            | Ciss                 | Ciss   |      | 2250 | -    | pF   |  |
| Output Capacitance  Reverse Transfer Capacitance |            | Coss                 | V <sub>DS</sub> = 50V, V <sub>GS</sub> =0V, f =1MHz            | -    | 370  | -    |      |  |
|  |            | Crss                 |  | -    | 8.5  | -    |      |  |
| Switching Characteristi                          | cs         |                      |  |      |      |      |      |  |
| Gate Resistance                                  |            | R <sub>G</sub>       | V <sub>DS</sub> = 0V, V <sub>GS</sub> =0V, f =1MHz             | -    | 1.2  | -    | Ω    |  |
| Total Gate Charge                                |            | Qg                   |  | -    | 21   | -    | nC   |  |
| Gate-Source Charge                               |            | Qgs                  | $V_{GS} = 10V$ , $V_{DS} = 50V$ , $I_{D} = 20A$                | -    | 4.8  | -    |      |  |
| Gate-Drain Charge                                |            | Q <sub>gd</sub>      |  | -    | 6.8  | -    |      |  |
| Turn-on Delay Time                               |            | t <sub>d(on)</sub>   |  | -    | 6    | -    |      |  |
| Rise Time Turn-off Delay Time                    |            | t <sub>r</sub>       | $V_{GS} = 10V, \ V_{DS} = 50V, R_G = 10\Omega, \\ I_{D} = 20A$ | -    | 3.6  | -    | nS   |  |
|  |            | t <sub>d(off)</sub>  |  | -    | 15.5 | -    |      |  |
| Fall Time  |            | tf                   | tr   |      | 2.6  | -    |      |  |
| Drain-Source Body Dioc                           | de Charact | eristics             |  |      |      |      |      |  |
| Diode Forward Voltage <sup>2</sup>               |            | V <sub>SD</sub>      | I <sub>S</sub> = 1A, V <sub>GS</sub> = 0V                      | -    | -    | 1    | V    |  |
| Continuous Source Current <sup>1,5</sup>         |            | Is                   | V <sub>G</sub> =V <sub>D</sub> =0V , Force Current             | -    | -    | 74   | Α    |  |
| Reverse Recovery Time                            |            | trr                  | V <sub>R</sub> =50V, I <sub>F</sub> =20A,                      | -    | 43   | -    | nS   |  |
| Reverse Recovery Charge                          |            | Qrr                  | dl <sub>F</sub> /dt=500A/μs                                    | -    | 202  | -    | nC   |  |

#### Notes:

- 1. The data tested by surface mounted on a 1 inch $^2$  FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq 300 us$  , duty cycle  $\leq 2\%$
- 3. The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}$ =25V,  $V_{\text{GS}}$ =10V, L=0.4mH,  $I_{\text{AS}}$ =32A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications , should be limited by total power dissipation.



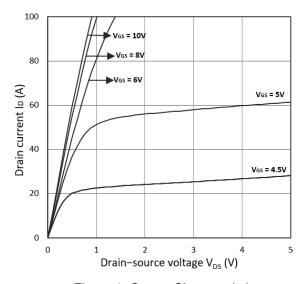


Figure 1. Output Characteristics

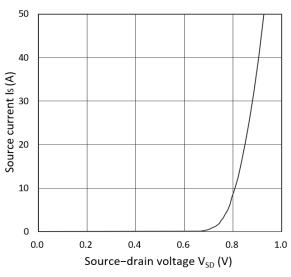


Figure 3. Forward Characteristics of Reverse

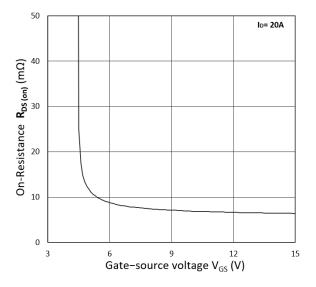


Figure 5.  $R_{DS(ON)}$  vs.  $V_{GS}$ 

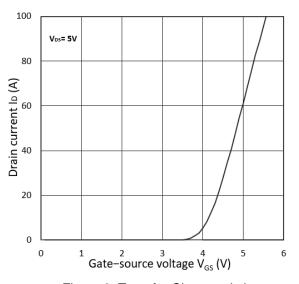


Figure 2. Transfer Characteristics

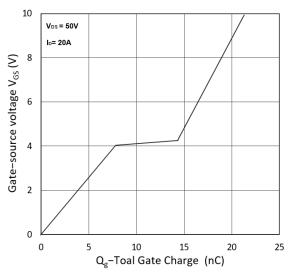


Figure 4. Gate Charge Characteristics

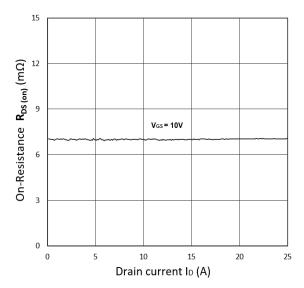
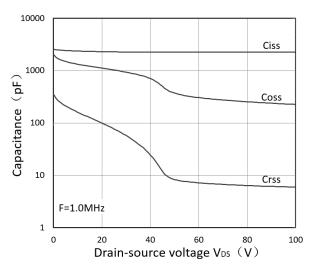


Figure 6. R<sub>DS(ON)</sub> vs. I<sub>D</sub>





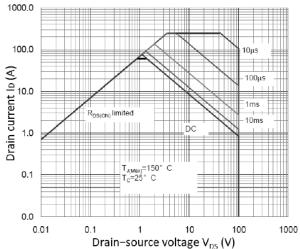


Figure 7. Capacitance Characteristics

Figure 8. Safe Operating Area

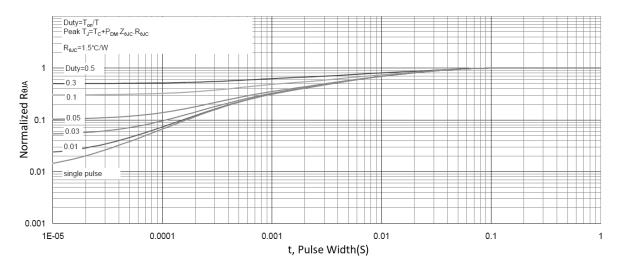


Figure 9. Normalized Maximum Transient Thermal Impedance

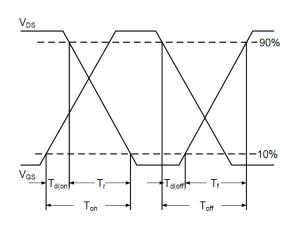


Figure 10. Switching Time Waveform

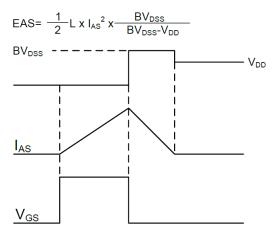
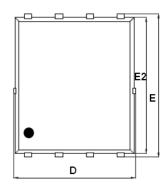


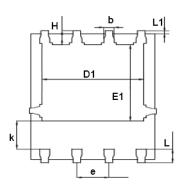
Figure 11. Unclamped Inductive Switching

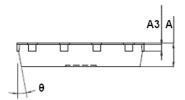
Waveform



## **Mechanical Dimensions for PDFN5060-8L**







## **COMMON DIMENSIONS**

|        | MM      |      |  |  |
|--------|---------|------|--|--|
| SYMBOL | MIN     | MAX  |  |  |
| А      | 0.90    | 1.20 |  |  |
| А3     | 0.15    | 0.35 |  |  |
| D      | 4.80    | 5.40 |  |  |
| E      | 5.90    | 6.35 |  |  |
| D1     | 3.61    | 4.31 |  |  |
| E1     | 3.30    | 3.92 |  |  |
| E2     | 5.65    | 6.06 |  |  |
| k      | 1.10    | -    |  |  |
| b      | 0.30    | 0.51 |  |  |
| е      | 1.27BSC |      |  |  |
| L      | 0.38    | 0.71 |  |  |
| L1     | 0.05    | 0.36 |  |  |
| Н      | 0.38    | 0.61 |  |  |
| θ      | 0°      | 12°  |  |  |

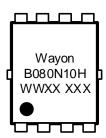
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## **Ordering Information**

| Part         | Part Package |          | Packing method |  |
|--------------|--------------|----------|----------------|--|
| WMB080N10HG2 | PDFN5060-8L  | B080N10H | Tape and Reel  |  |

## **Marking Information**



B080N10H = Device code

WWXX XXX= Date code

#### **Contact Information**

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